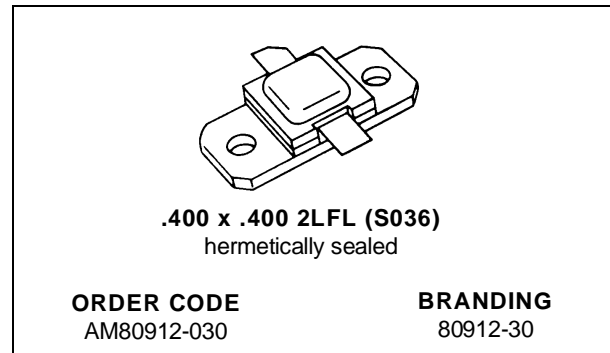


**RF & MICROWAVE TRANSISTORS
 SPECIALITY AVIONICS/JTIDS APPLICATIONS**

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- 15:1 VSWR CAPABILITY
- LOW RF THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- $P_{OUT} = 30$ W MIN. WITH 7.8 dB GAIN

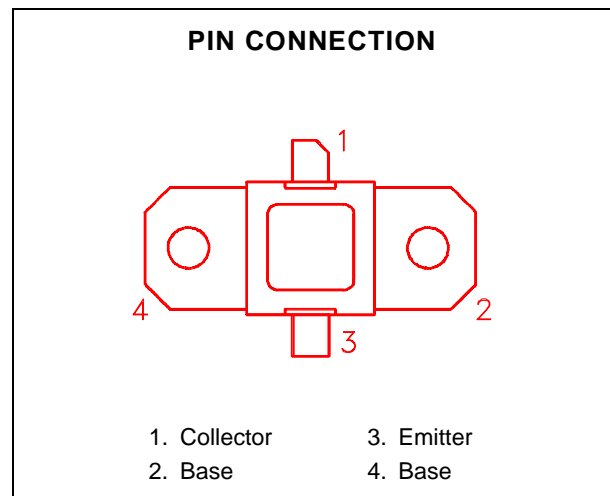

DESCRIPTION

The AM80912-030 device is a high power Class C transistor specifically designed for JTIDS pulsed output and driver applications.

This device is capable of operation over a wide range of pulse widths, duty cycles and temperatures and is capable of withstanding 15:1 output VSWR at rated RF conditions.

Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

The AM80912-030 is supplied in the hermetic metal/ceramic package with internal input matching structures.


ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$)

Symbol	Parameter	Value	Unit
P_{DISS}	Power Dissipation* ($T_C \leq 85^{\circ}C$)	75	W
I_C	Collector Current*	3.5	A
V_{CC}	Collector-Supply Voltage*	40	V
T_J	Junction Temperature (Pulsed RF Operation)	250	$^{\circ}C$
T_{STG}	Storage Temperature	- 65 to +200	$^{\circ}C$

THERMAL DATA

$R_{TH(j-c)}$	Junction-Case Thermal Resistance	2.2	$^{\circ}C/W$
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*Applies only to rated RF amplifier operation.

AM80912-030

ELECTRICAL SPECIFICATIONS ($T_{case} = 25^{\circ}C$)

STATIC

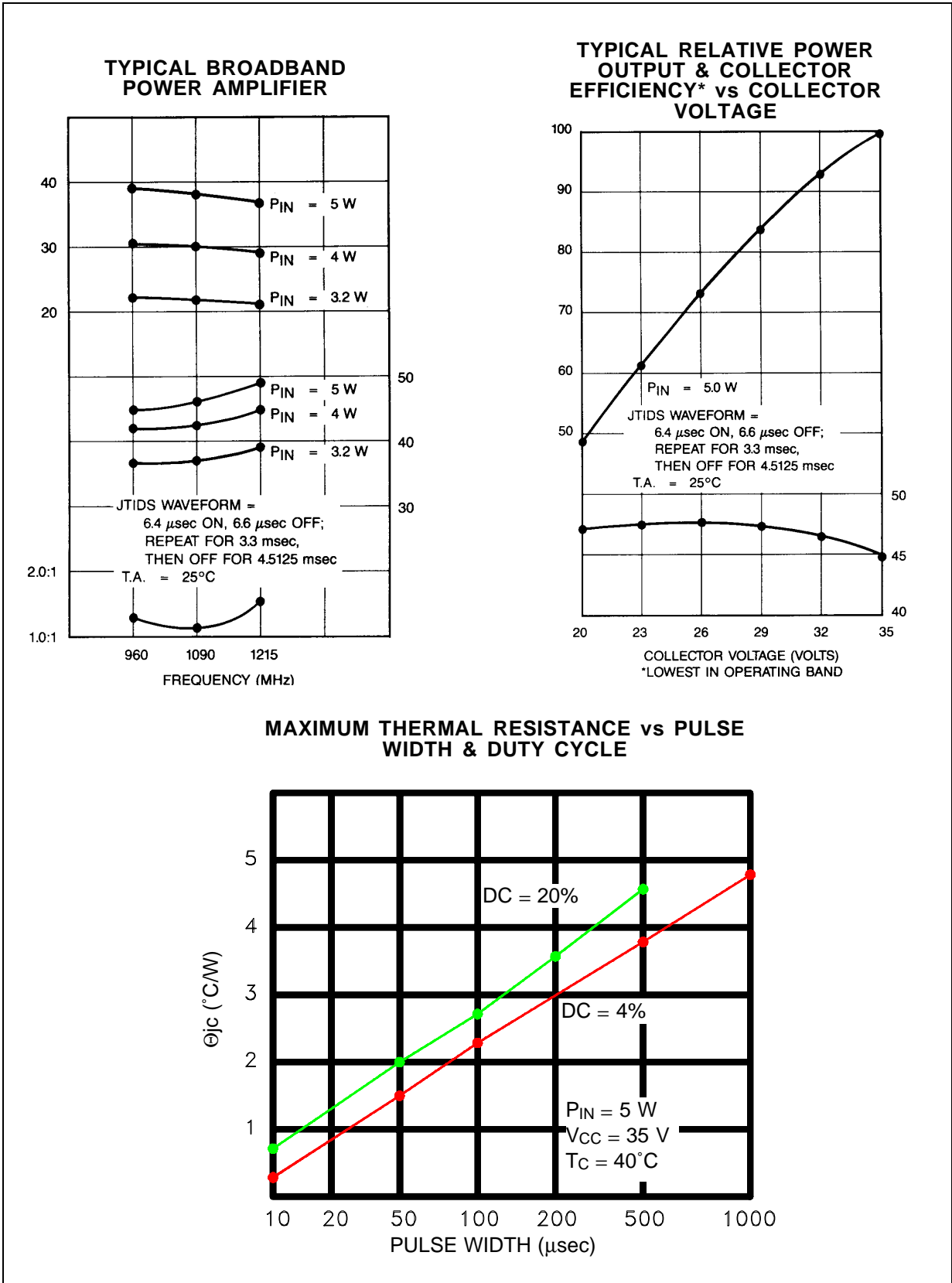
Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
BV_{CBO}	$I_C = 10mA$	55	—	—	V
BV_{EBO}	$I_E = 1mA$	3.5	—	—	V
BV_{CER}	$I_C = 20mA$ $R_{BE} = 10\Omega$	55	—	—	V
I_{CES}	$V_{CE} = 35V$	—	—	5.0	mA
h_{FE}	$V_{CE} = 5V$ $I_C = 1.0A$	15	—	150	—

DYNAMIC

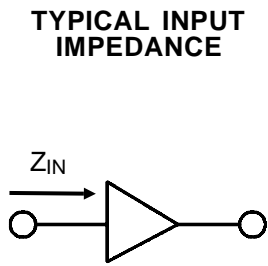
Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
P_{OUT}	$f = 960 \text{ — } 1215MHz$ $P_{IN} = 5.0W$ $V_{CC} = +35V$	30	36	—	W
η_C	$f = 960 \text{ — } 1215MHz$ $P_{IN} = 5.0W$ $V_{CC} = +35V$	40	45	—	%
G_P	$f = 960 \text{ — } 1215MHz$ $P_{IN} = 5.0W$ $V_{CC} = +35V$	7.8	8.6	—	dB

Note: Pulse format: 6.4 μs on 6.6 μs off, repeat for 3.3 ms, then off for 4.5125 ms.
Duty Cycle: Burst 49.2%, overall 20.8%

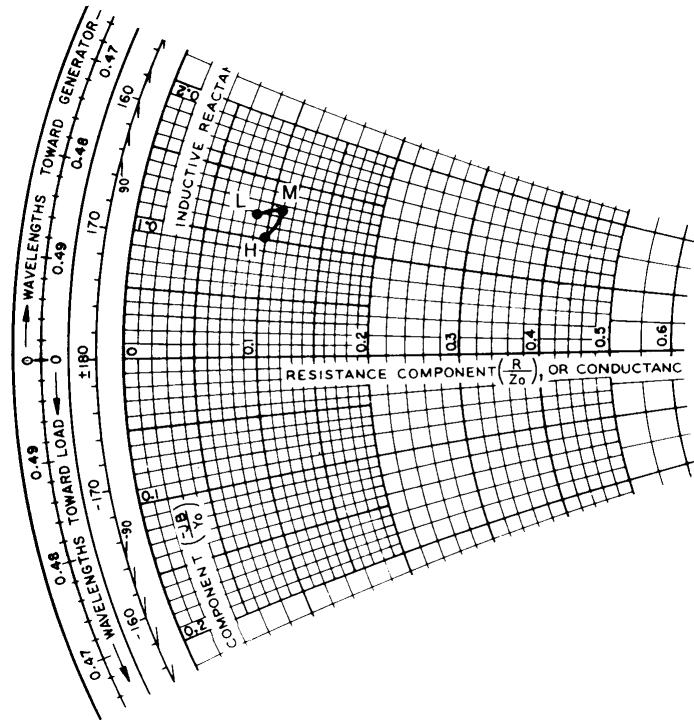
TYPICAL PERFORMANCE



IMPEDANCE DATA

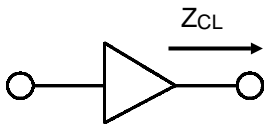


$P_{IN} = 5W$
 $V_{CC} = +35V$
 $Z_0^* = 50\Omega$

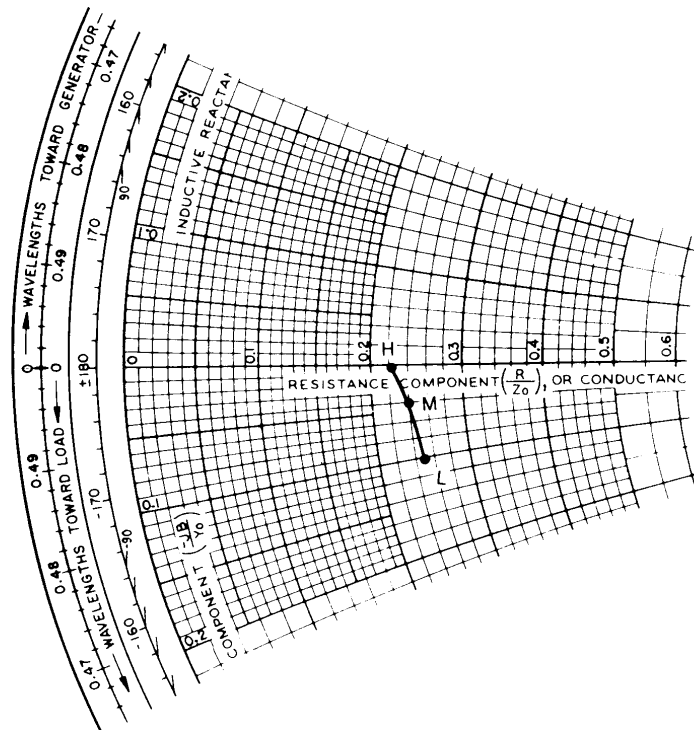


FREQ.	$Z_{IN} (\Omega)$	$Z_{CL} (\Omega)$
L = 960 MHz	$4.5 + j 6.0$	$11.0 - j 0.5$
M = 1090 MHz	$5.5 + j 6.3$	$12.0 - j 2.0$
H = 1215 MHz	$5.0 + j 5.0$	$12.5 - j 5.0$

TYPICAL COLLECTOR LOAD IMPEDANCE

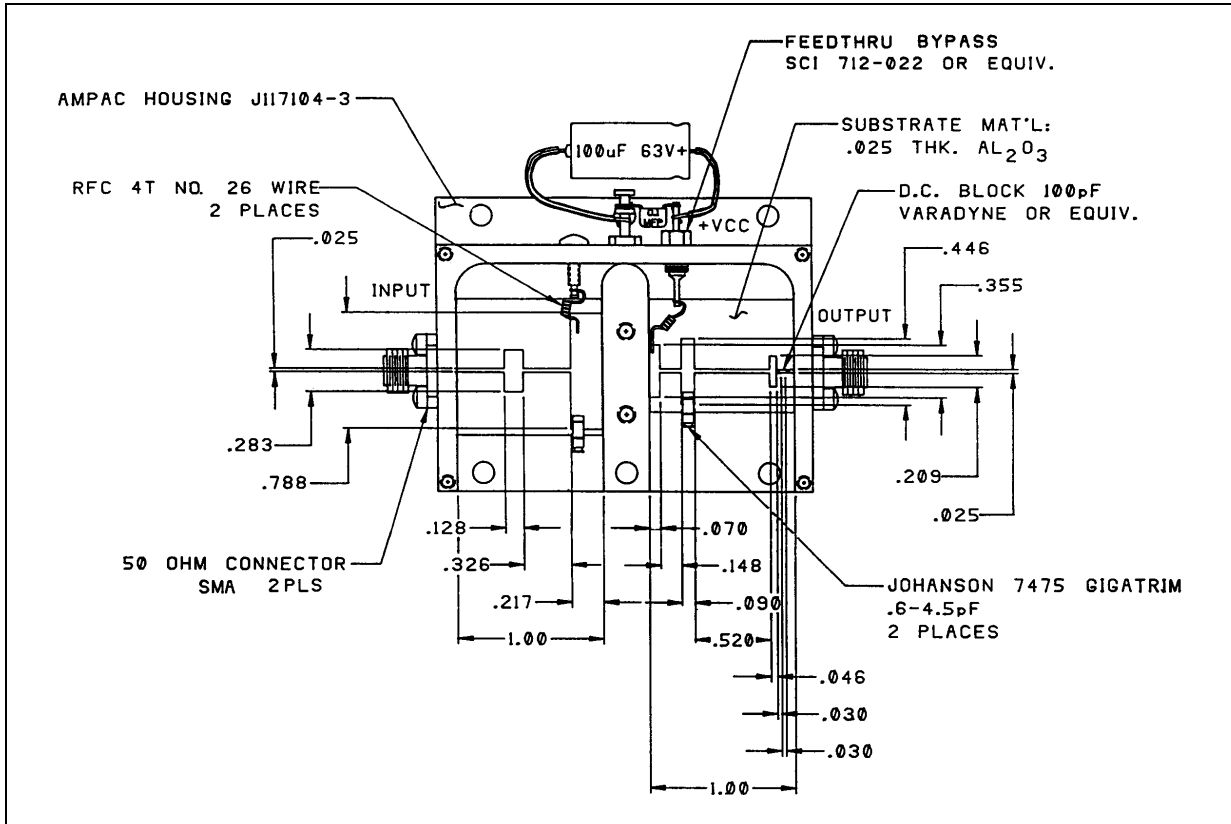


$P_{IN} = 5W$
 $V_{CC} = +35V$
 $Z_0^* = 50\Omega$

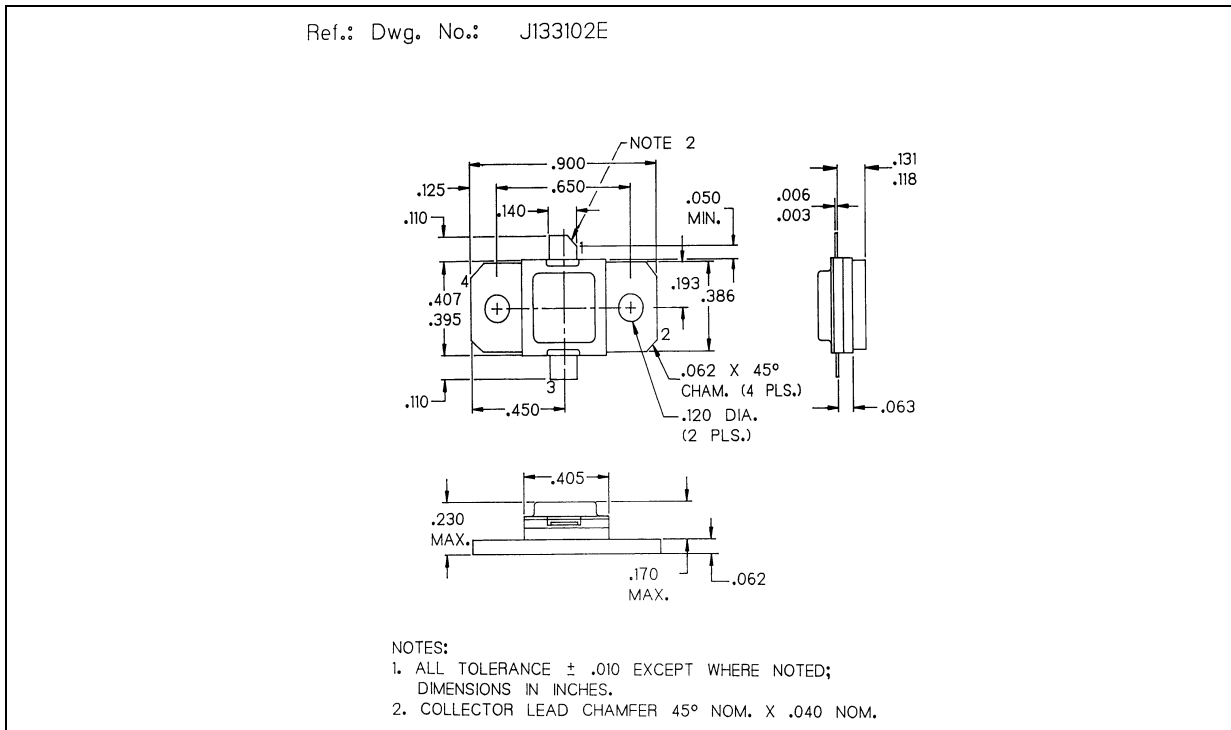


*Normalized Impedance

TEST CIRCUIT



PACKAGE MECHANICAL DATA



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